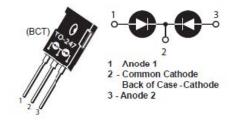
# 700V, 10A Silicon Carbide Schottky Dual Diode

### **Product Overview**

The silicon carbide (SiC) power Schottky barrier diode (SBD) product line from Microchip increases the performance over silicon diode solutions while lowering the total cost of ownership for high-voltage applications. The MSC010SDA070BCT device is a 700 V, 10 A SiC dual common cathode SBD in a three-lead TO-247 package.



#### **Features**

The following are key features of the MSC010SDA070BCT device:

- · No reverse recovery
- · Low forward voltage
- · Low leakage current
- Avalanche-energy rated
- RoHS compliant

#### **Benefits**

The following are benefits of the MSC010SDA070BCT device:

- · High switching frequency
- Low switching losses
- Low noise (EMI) switching
- Higher reliability systems
- · Increased system power density

#### **Applications**

The MSC010SDA070BCT device is designed for the following applications:

- Power factor correction (PFC)
- Anti-parallel diode
  - Switch-mode power supply
  - Inverters/converters
  - Motor controllers
- · Freewheeling diode
  - Switch-mode power supply
  - Inverters/converters
- Snubber/clamp diode

## 1. Device Specifications

This section shows the specifications of the MSC010SDA070BCT device. All ratings are per leg.

### 1.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings of the MSC010SDA070BCT device.  $T_C$  = 25 °C unless otherwise specified.

**Table 1-1. Absolute Maximum Ratings** 

Symbol	Parameter			Unit
$V_R$	Maximum DC reverse voltage	700	V	
$V_{RRM}$	Maximum peak repetitive reverse voltage			
V <sub>RWM</sub>	Maximum working peak reverse voltage			
I <sub>F</sub>	Maximum DC forward current T		24	Α
		T <sub>C</sub> = 135 °C	10	
		T <sub>C</sub> = 145 °C	8	
I <sub>FRM</sub>	Repetitive peak forward surge current (tp = 8.3 ms, half sine wave)			
I <sub>FSM</sub>	Non-repetitive forward surge current (tp = 8.3 ms, half sine wave)			
P <sub>TOT</sub>	Total power dissipation	T <sub>C</sub> = 25 °C	83	W
		T <sub>C</sub> = 110 °C	36	
E <sub>AS</sub>	Single-pulse avalanche energy (starting $T_J$ = 25 °C, peak $I_L$ = 10 A)	100		mJ

The following table shows the thermal and mechanical characteristics of the MSC010SDA070BCT device.

**Table 1-2. Thermal and Mechanical Characteristics** 

Symbol	Characteristic/Test Conditions	Min	Тур	Max	Unit
$R_{\theta JC}$	Junction-to-case thermal resistance		1.30	1.80	°C/W
T <sub>J</sub> , T <sub>STG</sub>	Operating junction and storage temperature range	<b>-</b> 55		175	°C
T <sub>L</sub>	Lead temperature for 10 seconds			300	
Wt	Package weight		0.22		oz
			6.2		g
Mounting torque, 6-32 or M3 screw				10	lbf-in
				1.1	N-m

### 1.2 Electrical Performance

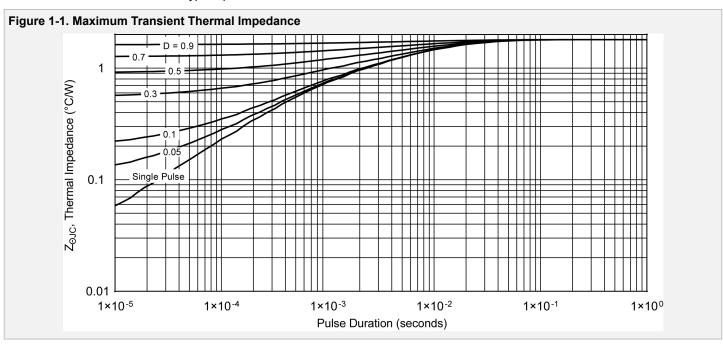
The following table shows the static characteristics of the MSC010SDA070BCT device.  $T_J$  = 25 °C unless otherwise specified.

**Table 1-3. Static Characteristics** 

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	Forward voltage	I <sub>F</sub> = 10 A, T <sub>J</sub> = 25 °C		1.5	1.8	V
		I <sub>F</sub> = 10 A, T <sub>J</sub> = 175 °C		1.8		
I <sub>RM</sub>	Reverse leakage current	V <sub>R</sub> = 700 V, T <sub>J</sub> = 25 °C		3	200	μA
		$V_R = 700 \text{ V}, T_J = 175 ^{\circ}\text{C}$		15		
Q <sub>C</sub>	Total capacitive charge	V <sub>R</sub> = 400 V		27		nC
CJ	Junction capacitance	V <sub>R</sub> = 1 V, f = 1 MHz		353		pF
		V <sub>R</sub> = 200 V, f = 1 MHz		54		
		V <sub>R</sub> = 400 V, f = 1 MHz		46		

### 1.3 Typical Performance Curves

This section shows the typical performance curves of the MSC010SDA070BCT device.



# **Device Specifications**

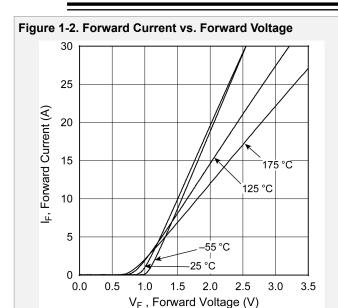


Figure 1-3. Max. Forward Current vs. Case Temp.

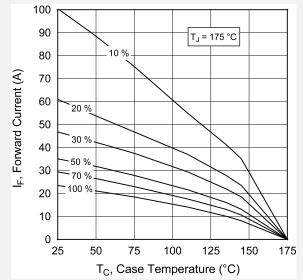


Figure 1-4. Max. Power Dissipation vs. Case Temp.

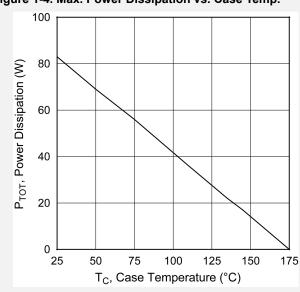
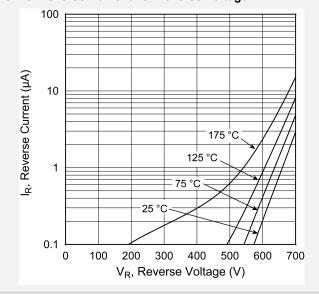
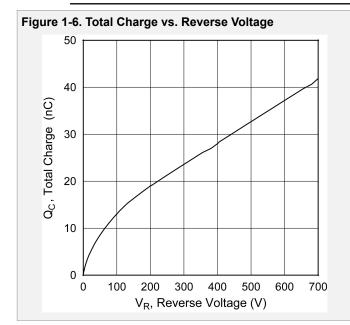
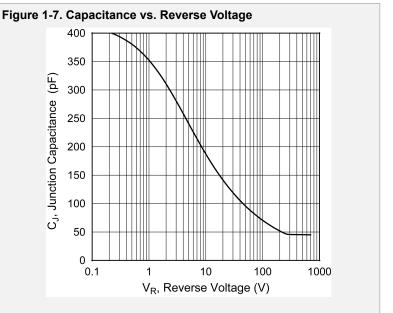


Figure 1-5. Reverse Current vs. Reverse Voltage



**Device Specifications** 





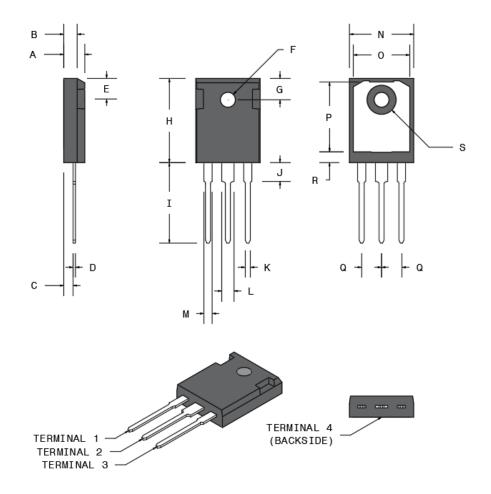
# 2. Package Specification

This section shows the package specification of the MSC010SDA070BCT device.

### 2.1 Package Outline Drawing

The following figure illustrates the TO-247 package outline of the MSC010SDA070BCT device.

Figure 2-1. Package Outline Drawing



The following table shows the TO-247 dimensions and should be used in conjunction with the package outline drawing.

Table 2-1. TO-247 Dimensions

Symbol	Min (mm)	Max (mm)	Min (in.)	Max (in.)
Α	4.69	5.31	0.185	0.209
В	1.49	2.49	0.059	0.098
С	2.21	2.59	0.087	0.102
D	0.40	0.79	0.016	0.031
E	5.38	6.20	0.212	0.244

# **Package Specification**

continued					
Symbol	Min (mm)	Max (mm)	Min (in.)	Max (in.)	
F	3.50	3.81	0.138	0.150	
G	6.15 BSC		0.242 BSC	0.242 BSC	
Н	20.80	21.46	0.819	0.845	
I	19.81	20.32	0780	0.800	
J	4.00	4.50	0.157	0.177	
K	1.01	1.40	0.040	0.055	
L	2.87	3.12	0.113	0.123	
М	1.65	213	0.065	0.084	
N	15.49	16.26	0.610	0.640	
0	13.50	14.50	0.531	0.571	
Р	16.50	17.50	0.650	0.689	
Q	5.45 BSC		0.215 BSC	'	
R	2.00	2.75	0.079	0.108	
S	7.10	7.50	0.280	0.295	
Terminal 1	Anode 1	Anode 1			
Terminal 2	Common cathode	Common cathode			
Terminal 3	Anode 2	Anode 2			
Terminal 4	Common cathode	Common cathode			

# 3. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

### Table 3-1. Revision History

Revision	Date	Description
A	08/2022	Document created.

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ISBN: 978-1-6683-1059-5

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